Evaluation Module for the TPS54540 Step-Down Converter

This user's guide contains information for the TPS54540EVM-558 evaluation module (PWR558) including the performance specifications, schematic, and the bill of materials.

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1 Introduction

This user's guide contains background information for the TPS54540 as well as support documentation for the TPS54540EVM-558 evaluation module (PWR558). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54540EVM-558.



Figure 1. TPS54540EVM-558 Board

1.1 Background

The TPS54540 DC-DC converter is designed to provide up to a 5-A output from an input voltage source of 4.5 V to 42 V. Rated input voltage and output current range for the evaluation module are given in Table 1. This evaluation module is designed to demonstrate the small, printed-circuit-board (PCB) areas that may be achieved when designing with the TPS54540 regulator. The switching frequency is externally set at a nominal 400 kHz. The high-side MOSFET is incorporated inside the TPS54540 package along with the gate-drive circuitry. The compensation components are external to the integrated circuit (IC), and an external resistor divider allows for an adjustable output voltage. Additionally, the TPS54540 provides an adjustable undervoltage lockout with hysteresis through an external resistor divider. The absolute maximum input voltage is 42 V for the TPS54540EVM-558.

Table 1. Input Voltage and Output Current Summary

EVM	Input Voltage Range	Output Current Range
TPS54540EVM-558	V_{IN} = 6 V to 42 V	I_{OUT} = 0 A to 5 A

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1.2 Performance Specification Summary

A summary of the TPS54540EVM-558 (EVM) performance specifications is provided in Table 2. Specifications are given for an input voltage of V_{IN} = 12 V and an output voltage of 3.3 V, unless otherwise specified. This EVM is designed and tested for V_{IN} = 6 V to 42 V. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. TPS54540EVM-558 Performance Specification Summary

Specification	Test Conditions		MIN	TYP	MAX	Unit
V_{IN} voltage range			6	12	42	V
Output voltage set point				3.3		V
Output current range	V_{IN} = 6 V to 42 V		0		5	A
Line regulation	I_{OUT} = 5 A, V_{IN} = 6 V to 42 V			±0.2%		
Load regulation	V_{IN} = 12 V, I_{OUT} = 0.001 A to 5 A			±0.3%		
Load transient response	I_{OUT} = 1.25 A to 3.75 A	Voltage change		–120		mV
		Recovery time		250		µs
	I_{OUT} = 3.75 A to 1.25 A	Voltage change		120		mV
		Recovery time		250		µs
Loop bandwidth	V_{IN} = 12 V, I_{OUT} = 5 A			31		kHz
Phase margin	V_{IN} = 12 V, I_{OUT} = 5 A			59		°
Input voltage ripple	I_{OUT} = 5 A			200		mVpp
Output voltage ripple	I_{OUT} = 5 A			10		mVpp
Output rise time				2.6		ms
Operating frequency				400		kHz
Maximum efficiency	TPS54540EVM-558, V_{IN} = 12 V, I_{OUT} = 1.5 A			87.5%		
DCM threshold	V_{IN} = 12 V			560		mA
Pulse skipping threshold	V_{IN} = 12 V			18		mA
No load input current	V_{IN} = 12 V			241		µA
UVLO start threshold				5.75		V
UVLO stop threshold				4.5		V

1.3 Schematic

Figure 2 is the schematic for the EVM.

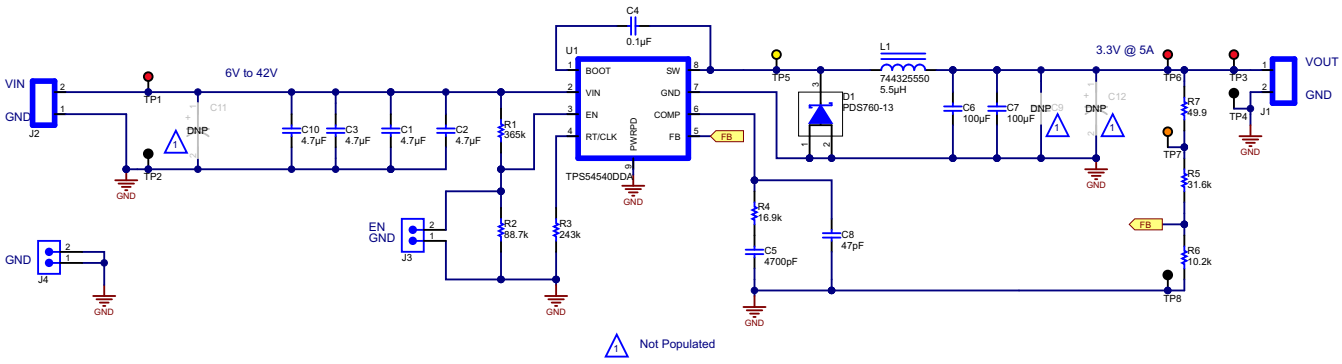


Figure 2. TPS54540EVM-558 Schematic

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1.4 Modifications

These evaluation modules are designed to provide access to the features of the TPS54540. Some modifications can be made to this module. Component selection for modifications can be done with the aid of WEBENCH or the excel spreadsheet (SLVC452) located on the product page.

1.4.1 Output Voltage Set Point

To change the output voltage of the EVM, the value of resistor R5 (R_{HS}) should be changed while keeping R6 (R_{LS}) fixed. The output voltage can be adjusted to a minimum of the 0.8 V internal reference. The value of R5 for a specific output voltage can be calculated using Equation 1:

$$R_{HS} = R_{LS} \times \left(\frac{Vout - 0.8V}{0.8\ V} \right) \quad (1)$$

Table 3 lists the R5 values for some common output voltages assuming R6 = 10.2 kΩ. Note V_{IN} must be in a range to keep the on time greater than the minimum on-time. The values given in Table 3 are standard 1% values, not the exact value calculated using Equation 1.

Table 3. R5 Values for Common Output Voltages

Output Voltage (V)	R5 Value (kΩ)
1.8	12.7
2.5	21.5
3.3	31.6
5.0	53.6

Be aware, changing the output voltage can affect the loop response. It may be necessary to modify the compensation components. Please see the TPS54540 data sheet (SLVSBX7) for details.

1.4.2 Adjustable UVLO

The undervoltage lockout (UVLO) can be adjusted externally using R1 (R_{UVLO1}) and R2 (R_{UVLO2}). The EVM is set for a start voltage of 5.75 V and stop voltage of 4.5 V, using R1 = 365 kΩ and R2 = 88.7 kΩ. Use Equation 2 and Equation 3 to calculate the required resistor values for R3 and R4, respectively, for different start and stop voltages. The typical values of the constants in the two equations are as follows: I_{HYS} = 3.4 µA, V_{ENA} = 1.2 V, and I_1 = 1.2 µA.

$$R_{UVLO1} = \frac{V_{START} - V_{STOP}}{I_{HYS}} \quad (2)$$

$$R_{UVLO2} = \frac{V_{ENA}}{\frac{V_{START} - V_{ENA}}{R_{UVLO1}} + I_1} \quad (3)$$

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2 Test Setup and Results

This section describes how to properly connect, set up, and use the EVM. The section also includes test results typical for the EVM covering efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, start up, and shutdown.

2.1 I/O Connections

This EVM includes I/O connectors and test points as shown in Table 4. A power supply capable of supplying at least 5 A must be connected to J2 through a pair of 20-AWG wires. The load must be connected to J1 through a pair of 20-AWG wires. The maximum load-current capability must be 5 A. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the V_{IN} input voltages with TP2 providing a convenient ground reference. TP3 is used to monitor the output voltage with TP4 as the ground reference.

Table 4. EVM Connectors and Test points

Reference Designator	Function
J1	V_{OUT}, 3.3 V at 5-A maximum
J2	V_{IN} (see Table 1 for V_{IN} range)
J3	EN jumper. Connect EN to ground to disable, open to enable.
J4	GND jumper for additional ground connections
TP1	V_{IN} test point at V_{IN} connector
TP2	GND test point at V_{IN}
TP3	Output voltage test point at V_{OUT} connector
TP4	GND test point at V_{OUT} connector
TP5	SW test point
TP6	V_{OUT} test point used for loop response measurements
TP7	Test point between voltage divider network and output. Used for loop response measurements.
TP8	GND test point

2.2 Efficiency

The efficiency of this EVM peaks at a load current of about 1.5 A with V_{IN} = 12 V, and then decreases as the load current increases towards full load. Figure 3 shows the efficiency for the EVM. Figure 4 shows the light-load efficiency for the EVM using a semi-log scale. Measurements are taken at an ambient temperature of 25°C. The efficiency may be lower at higher ambient temperatures due to temperature variation in the drain-to-source resistance of the internal MOSFET.

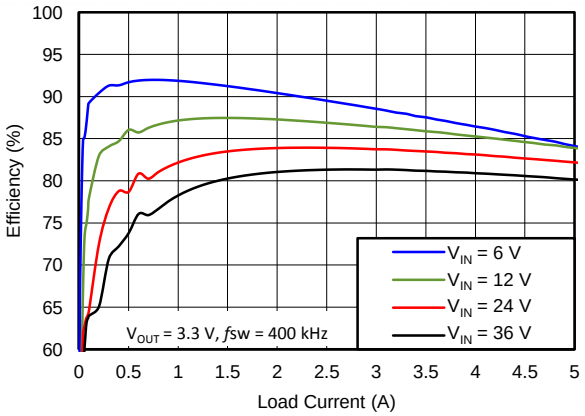


Figure 3. Efficiency Versus Load Current

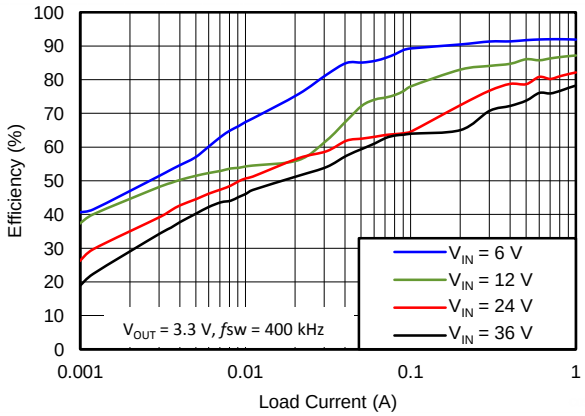


Figure 4. Light-Load Efficiency

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2.3 Output Voltage Regulation

The load regulation for the EVM is shown in Figure 5. The line regulation for the EVM is shown in Figure 6. Measurements are given for an ambient temperature of 25°C.

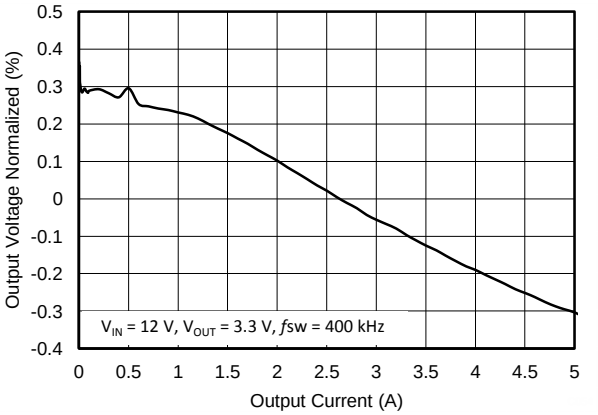


Figure 5. Regulation Versus Output Current

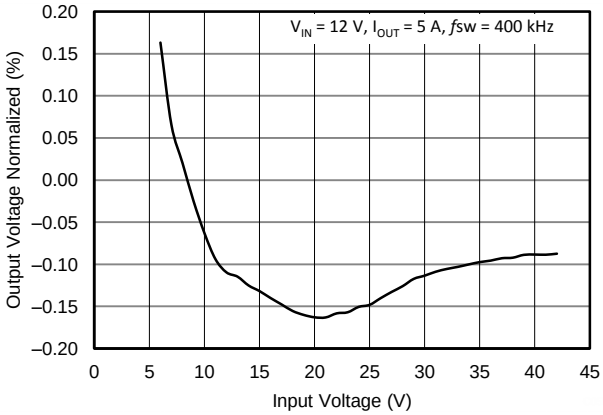


Figure 6. Regulation Versus Input Voltage

2.4 Load Transients and Loop Response

The EVM response to load transients is shown in Figure 7. The current step is from 25% to 75% of the maximum rated load at 12-V input. The current step slew rate is 100 mA/µs. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

The EVM loop-response characteristics are shown in Figure 8. Gain and phase plots are shown for V_{IN} voltage of 12 V. Load current for the measurement is 5 A.

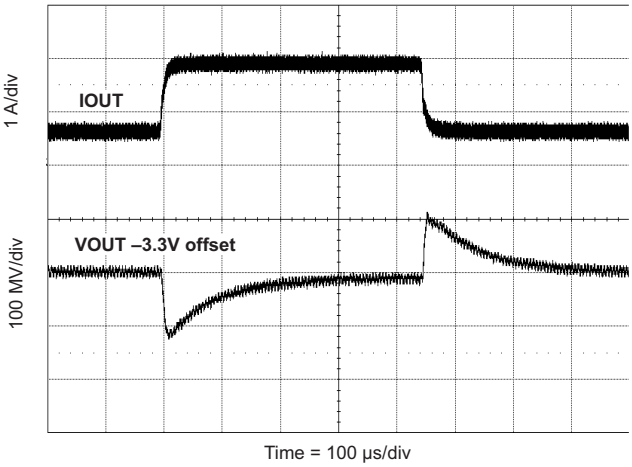


Figure 7. Load Transient Response

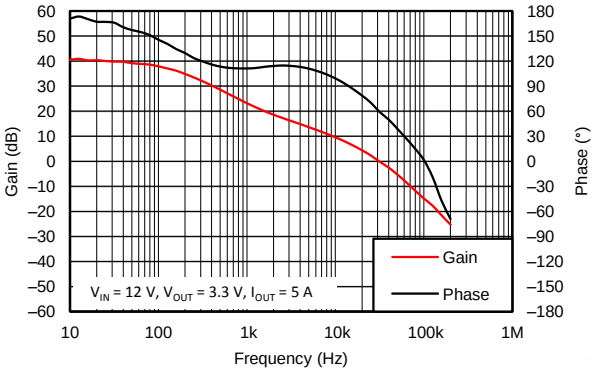


Figure 8. Loop Response

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2.5 Line Transients

The EVM response to line transients is shown in Figure 9. The input voltage step is from 8.0 V to 40 V. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

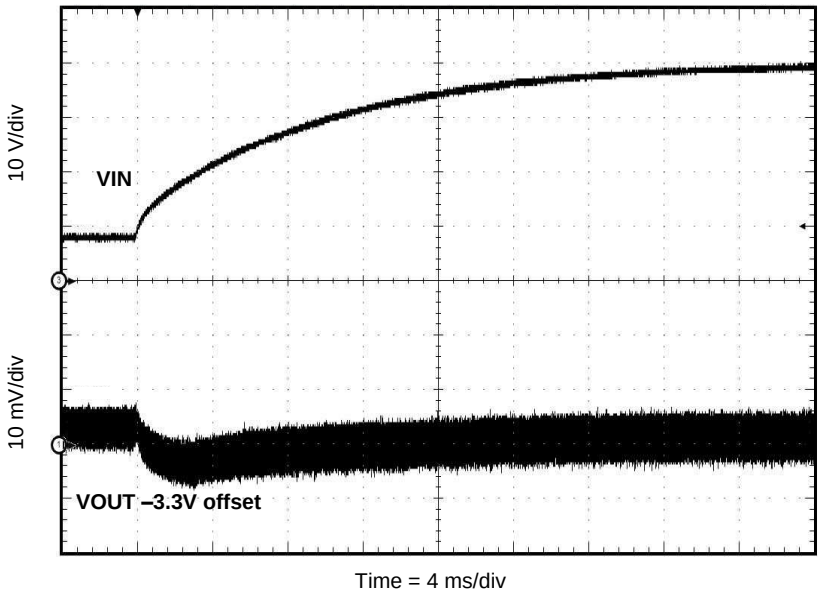


Figure 9. Line Transient Response

2.6 Input Voltage Ripple

The EVM CCM input voltage ripple is shown in Figure 10. The output current is the rated full load of 5 A and V_{IN} = 12 V. The voltage ripple is measured directly across the input capacitors.

The DCM input voltage ripple is shown in Figure 11. The output current is 0.1 A and V_{IN} = 12 V.

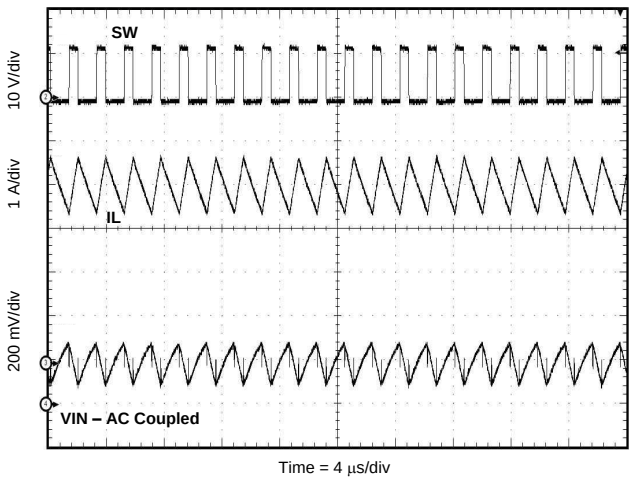


Figure 10. Input Voltage Ripple CCM

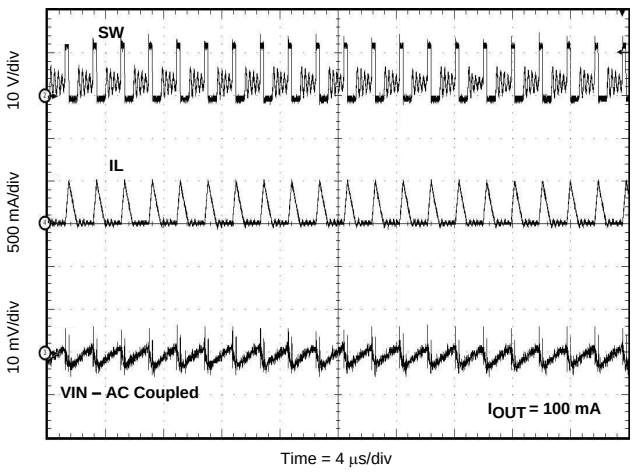


Figure 11. Input Voltage Ripple DCM

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2.7 Output Voltage Ripple

The EVM CCM output voltage ripple is shown in Figure 12. The output current is the rated full load of 5 A and V_{IN} = 12 V. The voltage ripple is measured directly across the output capacitors.

The DCM output voltage ripple is shown in Figure 13. The output current is 0.1 A and V_{IN} = 12 V.

The Pulse Skip Eco-mode™ output voltage ripple is shown in Figure 14. There is no external load on the output and V_{IN} = 12 V.

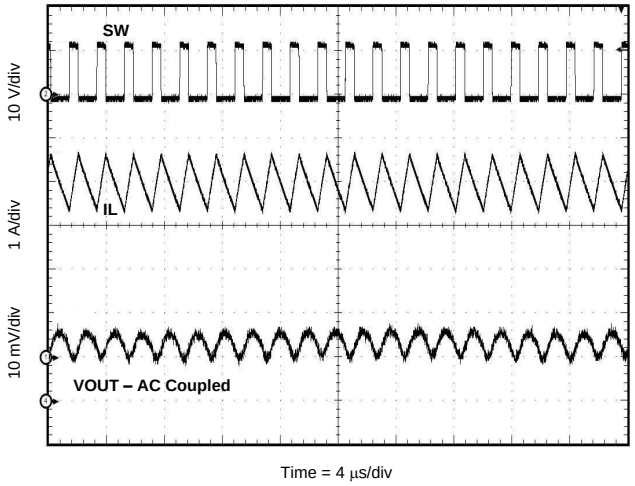


Figure 12. Output Voltage Ripple CCM

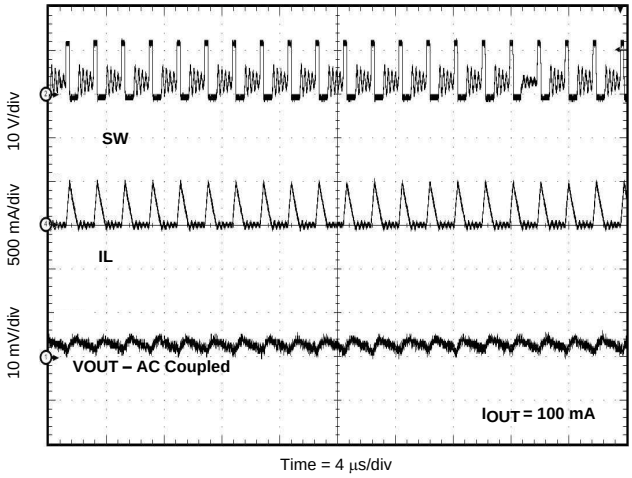


Figure 13. Output Voltage Ripple DCM

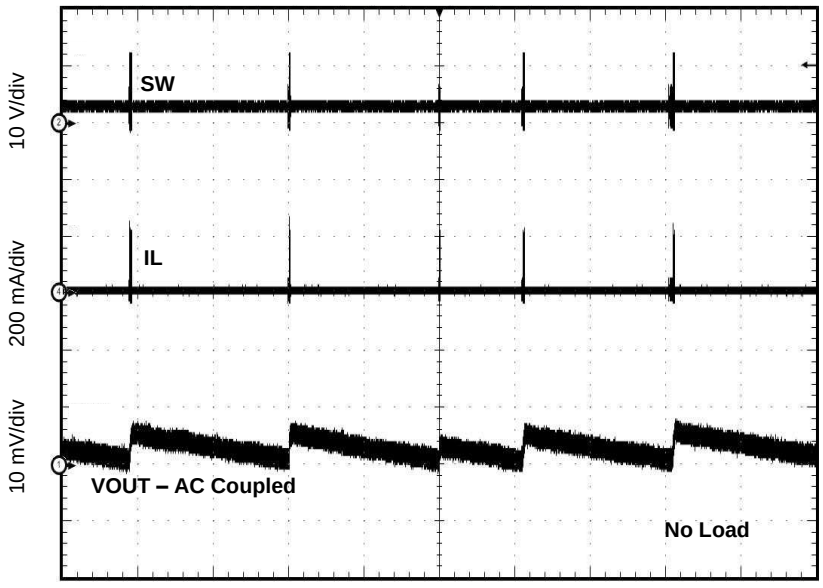


Figure 14. Output Voltage Ripple Eco-mode

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2.8 Start Up

The start up waveforms are shown in Figure 15, Figure 16, and Figure 17. The input voltage for these plots is 12 V with a 5-A resistive load. In Figure 15 the top trace shows V_{IN}, the middle trace shows EN, and the bottom trace shows V_{OUT}. The input voltage is initially applied, and when the input reaches the undervoltage lockout threshold, the start up sequence begins and the output ramps up toward the set value of 3.3 V.

In Figure 16 the input voltage is initially applied with EN held low. When EN is released, the start up sequence begins and the output ramps up toward the set value of 3.3 V.

In Figure 17 the input voltage is initially applied with EN held low. An external voltage of 1.8 V is supplied to V_{OUT}. When EN is released, the start up sequence begins and the internal reference ramps up from 0 V with the internal soft-start. When the internal reference reaches the FB voltage the output begins ramping toward the set value of 3.3 V.

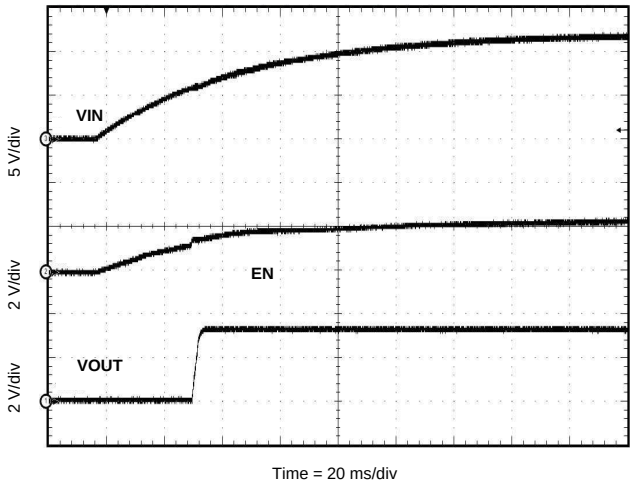


Figure 15. Start Up Relative to V_{IN}

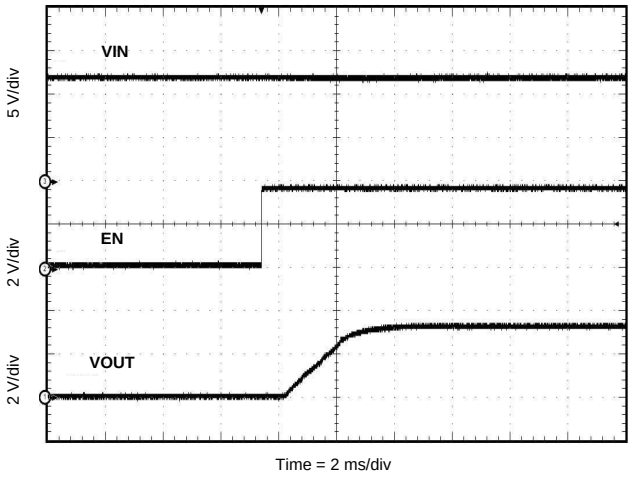


Figure 16. Start Up Relative to EN

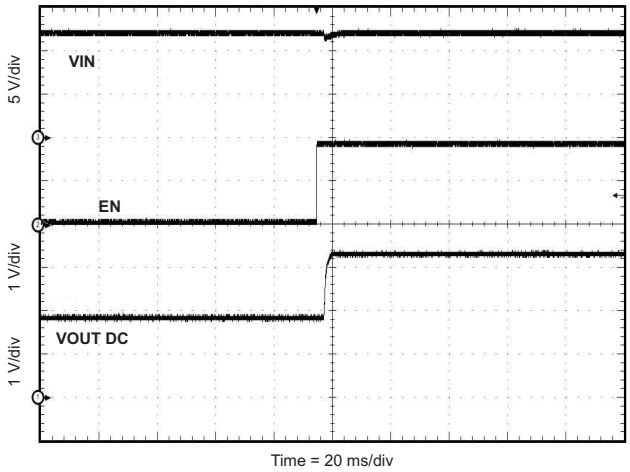


Figure 17. Prebias Start Up Relative to EN

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2.9 Shutdown

The shutdown waveforms are shown in Figure 18 and Figure 19. The input voltage for these plots is 12 V with a 5-A resistive load. The top trace shows V_{IN}, the middle trace shows EN, and the bottom trace shows V_{OUT}. In Figure 18 the input voltage is removed, and when the input falls below the undervoltage lockout threshold, the TPS54540 shuts down and the output falls to ground.

In Figure 19, the input voltage is held at 12 V, and EN is shorted to ground. When EN is grounded, the TPS54540 is disabled, and the output voltage discharges to ground.

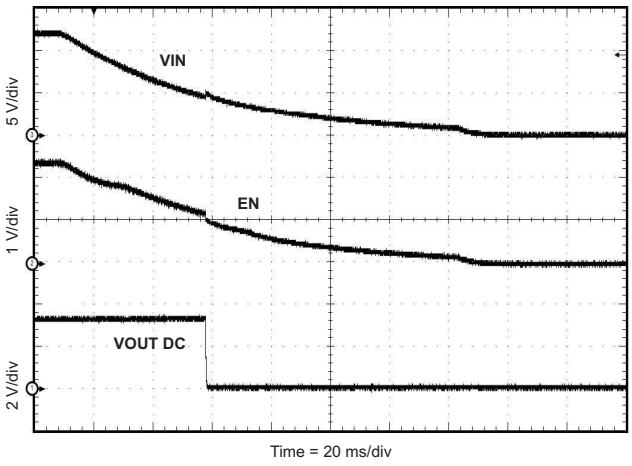


Figure 18. Shutdown Relative to V_{IN}

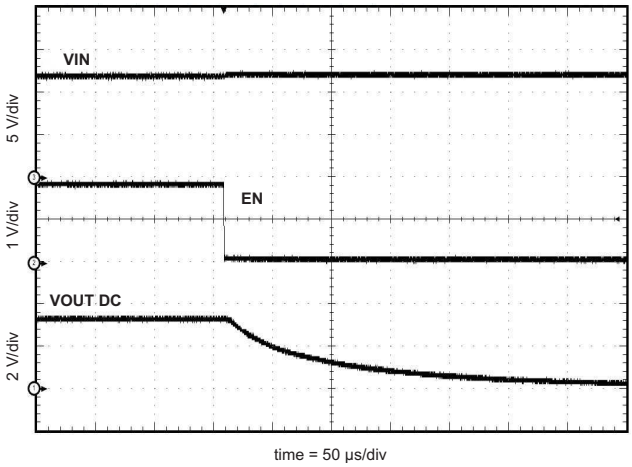


Figure 19. Shutdown Relative to EN

2.10 Low Dropout Operation

For improved low dropout operation, the TPS54540 includes a small integrated low-side MOSFET to pull SW to GND when the BOOT to SW voltage drops below 2.1 V. This recharges the BOOT capacitor for driving the high-side MOSFET. Figure 20 shows the steady state operation and Figure 21 shows the start up and shutdown in a low dropout condition. Both measurements are taken with a 5-V output.

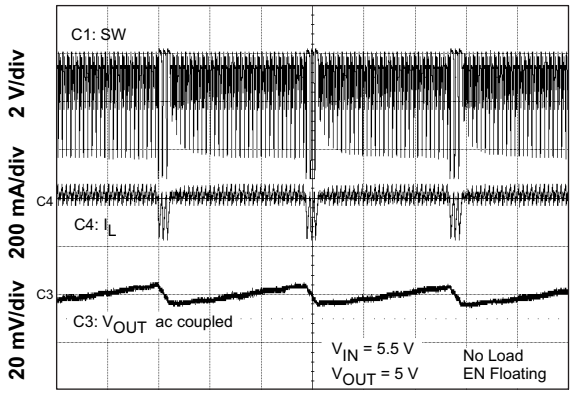


Figure 20. Low Dropout Operation

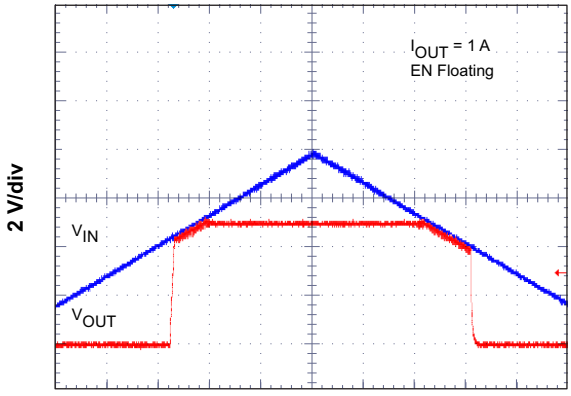


Figure 21. Low Dropout Start Up and Shutdown

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3 Board Layout

This section provides a description of the EVM, board layout, and layer illustrations.

3.1 Layout

The board layout for the EVM is shown in Figure 22 through Figure 26. The top-side layer of the EVM is laid out in a manner typical of a user application. The top and bottom layers are 2-oz copper.

The top layer contains the main power traces for V_{IN}, V_{OUT}, and SW. Also on the top layer are connections for the remaining pins of the TPS54540 and a large area filled with ground. The bottom layer contains ground and a signal route for the bootstrap capacitor. The top and bottom and internal ground traces are connected with multiple vias placed around the board including six vias directly under the TPS54540 device to provide a thermal path from the top-side ground plane to the bottom-side ground plane.

The input decoupling capacitors (C1-C3, C10), bootstrap capacitor (C4), and frequency set resistor (R3) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper V_{OUT} trace past the output connector (J1). For the TPS54540, an additional input bulk capacitor may be required (C11), depending on the EVM connection to the input supply.

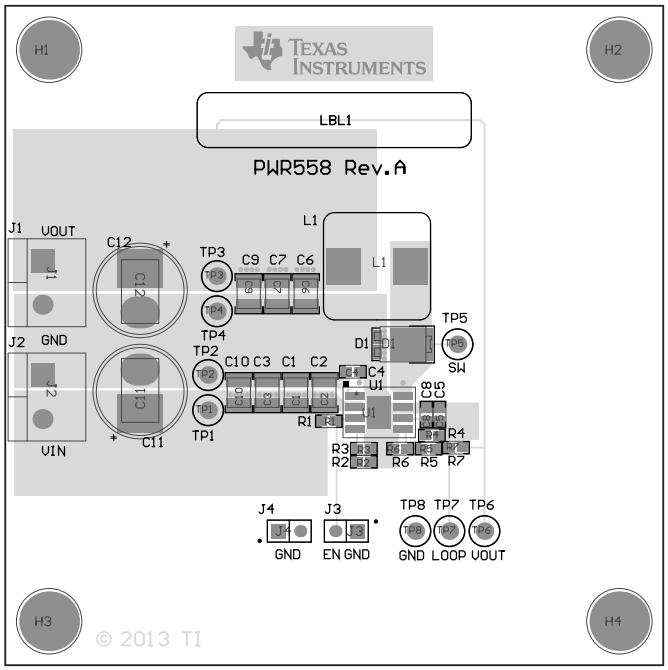


Figure 22. TPS54540EVM-558 Top Assembly and Silkscreen

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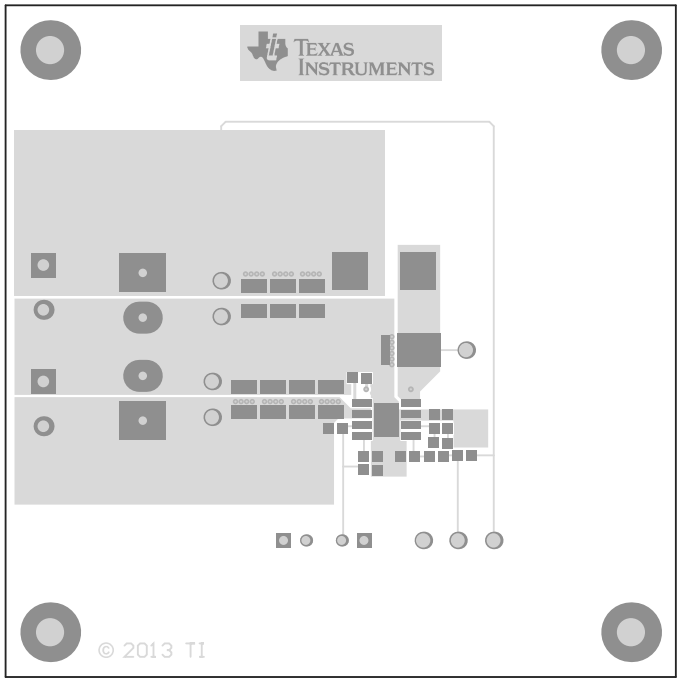


Figure 23. TPS54540EVM-558 Top-Side Layout

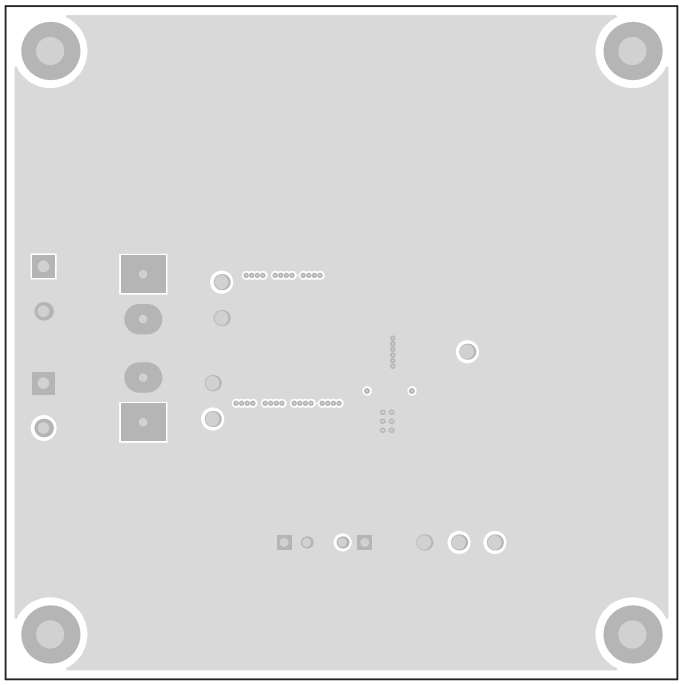


Figure 24. TPS54540EVM-558 Layer 2 Layout

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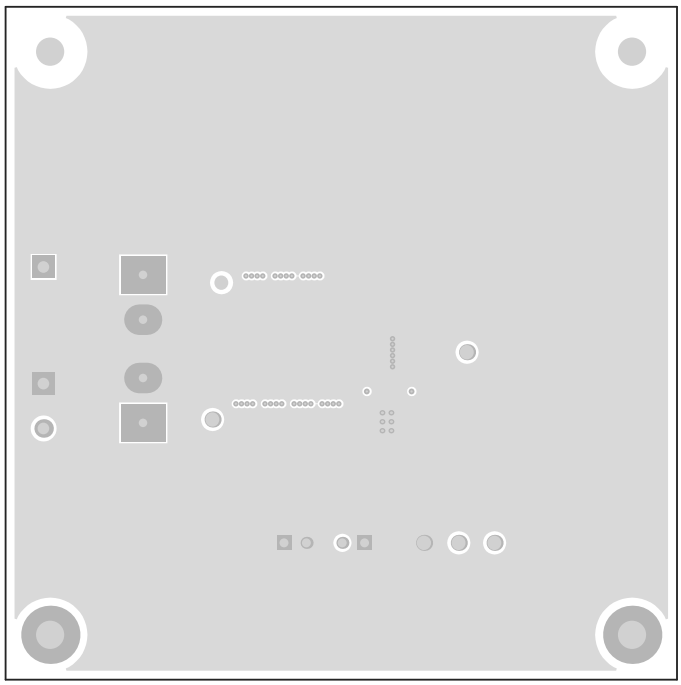


Figure 25. TPS54540EVM-558 Layer 3 Layout

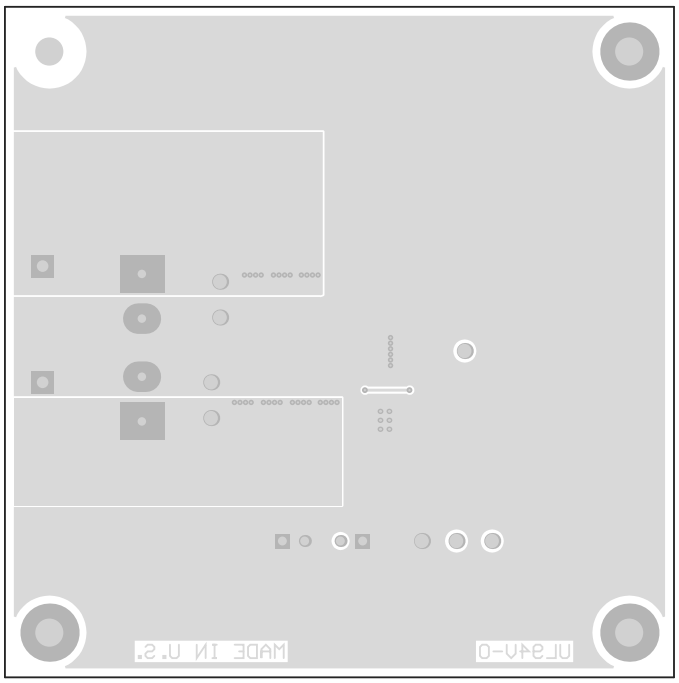


Figure 26. TPS54540EVM-558 Bottom-Side Layout

3.2 Estimated Circuit Area

The estimated printed-circuit-board area for the components used in this design is 1.025 in^2 (661 mm^2). This area does not include test points or connectors. This design uses 0603 components for easy modifications. The area can be reduced by using smaller-sized components.

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4 Bill of Materials

Table 5 presents the bill of materials for the EVM.

Table 5. TPS54540EVM-558 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
2	C1-3, C10	4.7 µF	CAP, CERM, 4.7uF, 50V, +/-10%, X7R, 1210	1210	STD	STD
1	C4	0.1 µF	CAP, CERM, 0.1uF, 10V, +/-10%, X7R, 0603	0603	STD	STD
1	C5	4700 pF	CAP, CERM, 4700pF, 50V, +/-5%, X7R, 0603	0603	STD	STD
2	C6	100 µF	CAP, CERM, 100uF, 6.3V, +/-20%, X5R, 1210	1210	STD	STD
1	C8	47 pF	CAP, CERM, 47pF, 50V, +/-5%, C0G/NP0, 0603	0603	STD	STD
0	C9, C11-12	open	CAP	Multi sizes	Engineering Only	STD
1	D1	PDS760-13	Diode, Schottky, 60V, 7A, PowerDI5	PowerDI5	PDS760-13	Diodes Inc
1	J3-4	PEC02SAAN	Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator	TSW-102-07-G-S	TSW-102-07-G-S	Samtec, Inc.
2	J1-2	ED120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35 inch	ED120/2DS	OST
1	L1	5.6 µH	Inductor, Shielded Drum Core, Superflux, 5.5uH, 10A, 0.0112 ohm, SMD	WE-HC6	744325550	WE
1	R1	365 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R2	88.7 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R3	243 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R4	16.9 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R5	31.6 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R6	10.2 kΩ	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	R7	49.9 Ω	Resistor, chip, 1/16W, 1%	0603	STD	STD
1	SH1		Shunt, 100mil, Gold plated, Black	Shunt	SNT-100-BK-G	Samtec, Inc.
1	TP6	5013	Test point, orange, thru hole	0.125 × 0.125 in	5013	Keystone
1	TP7	5014	Test point, yellow, thru hole	0.125 × 0.125 in	5014	Keystone
3	TP1 TP3 TP5	5010	Test point, red, thru hole	0.125 × 0.125 in	5010	Keystone
3	TP2 TP4 TP8	5011	Test point, black, thru hole	0.125 × 0.125 in	5011	Keystone
1	U1	TPS54540DDA	IC, 42V, 5A, Low Iq, Current Mode, Non-Synchronous Monolithic Buck	HSOIC	TPS54540DDA	TI
1	–		PCB, 3 in × 3 in × 0.062 in		PWR558	Any

Notes: 1. These assemblies are ESD sensitive, observe ESD precautions.
2. These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
4. Ref designators marked with an asterisk ('**') cannot be substituted. All other components can be substituted with equivalent MFG's components.

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Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

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REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of this Product in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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http://www.tij.co.jp

EVALUATION BOARD/KIT/MODULE (EVM)
WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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